

60V PNP MEDIUM POWER LOW SATURATION TRANSISTOR IN SOT223
Features

- $BV_{CEO} > -60V$
- $I_C = -5.5A$ High Continuous Collector Current
- $I_{CM} = -15A$ Peak Pulse Current
- Low Saturation Voltage $V_{CE(sat)} < -70mV @ -1A$
- $R_{SAT} = 39m\Omega$ for a Low Equivalent On-Resistance
- h_{FE} Specified Up to $-10A$ for a High Gain Hold Up
- Complementary NPN Type: ZX5T851G
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

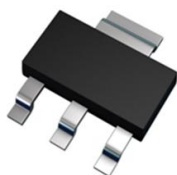
Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads.
Solderable per MIL-STD-202, Method 208 
- Weight: 0.112 grams (Approximate)

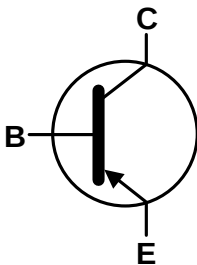
Applications

- DC-DC Converters
- MOSFET & IGBT Gate Drivers
- Charging Circuits
- Power Switches
- Motor Control

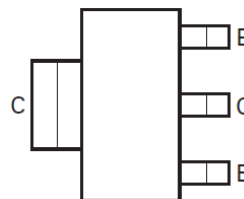
SOT223



Top View



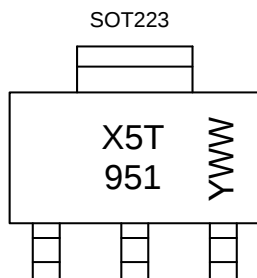
Device Symbol


 Top View
 Pin-Out

Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZX5T951GTA	X5T951	7	12	1,000
ZX5T951GTC	X5T951	13	12	4,000

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information


X5T 951 = Product Type Marking Code
 YWW = Date Code Marking
 Y or $\bar{Y}$ = Last Digit of Year (ex: 5= 2015)
 WW or $\bar{WW}$ = Week Code (01~53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-100	V
Collector-Emitter Voltage	V _{CEO}	-60	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-5.5	A
Peak Pulse Current	I _{CM}	-15	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

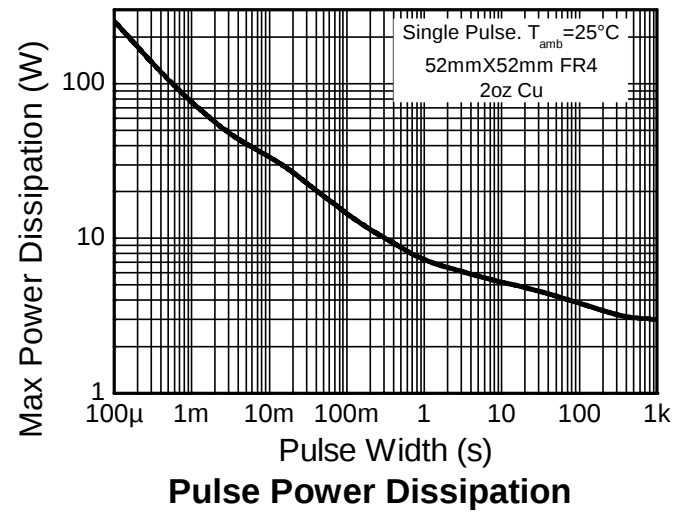
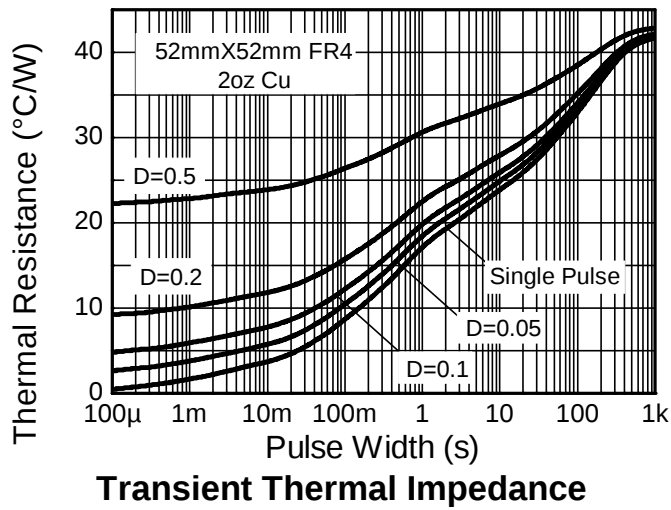
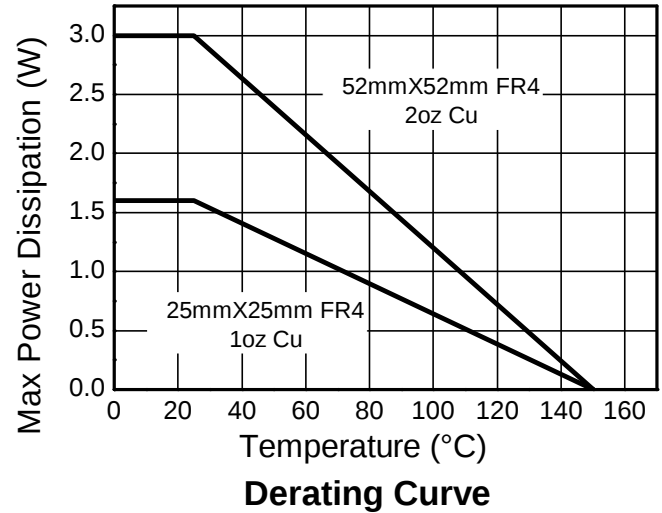
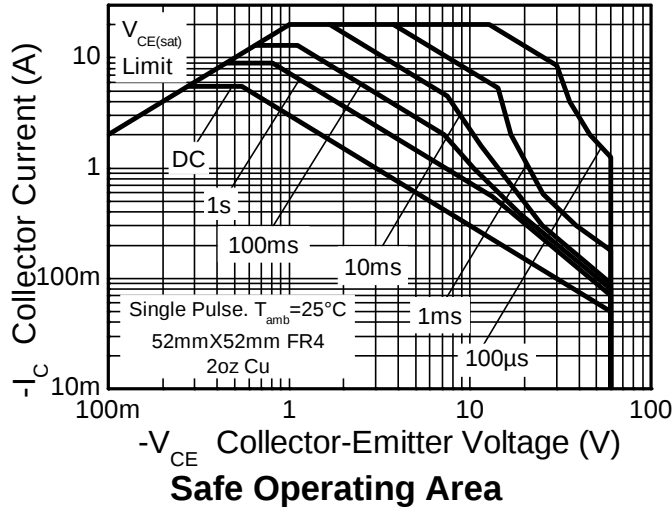
Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	3.0	W
Linear Derating Factor		24	
		1.6	
		12.8	°C/W
Thermal Resistance, Junction to Ambient	R _{θJA}	42	°C/W
	R _{θJA}	78	
Thermal Resistance Junction to Lead	R _{θJL}	10.48	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
- For a device surface mounted on 52mm x 52mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 - Same as Note (5), except the device is surface mounted on 25mm x 25mm with 1oz copper.
 - Thermal resistance from junction to solder-point (at the end of the collector lead).
 - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating Information

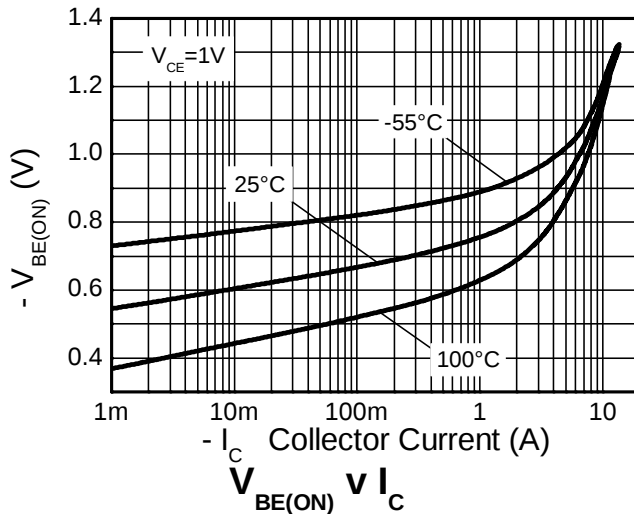
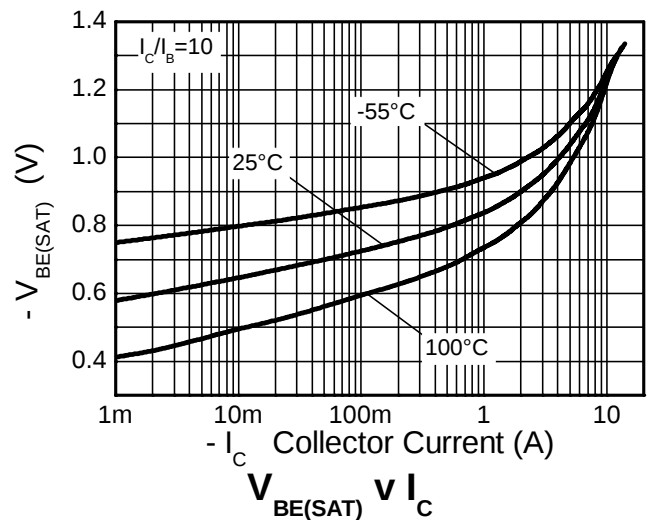
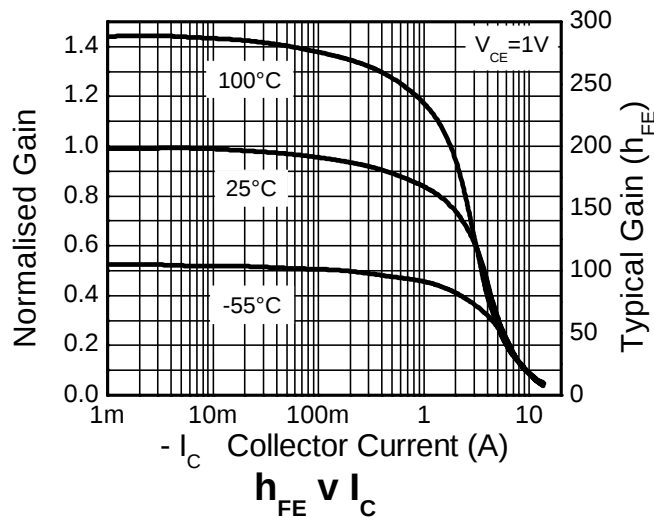
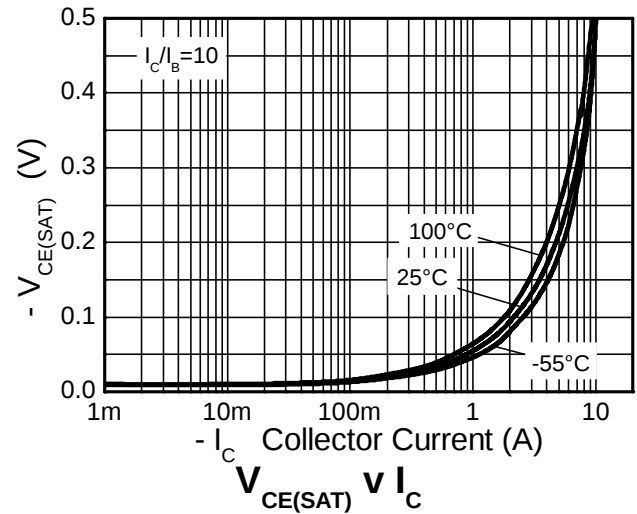
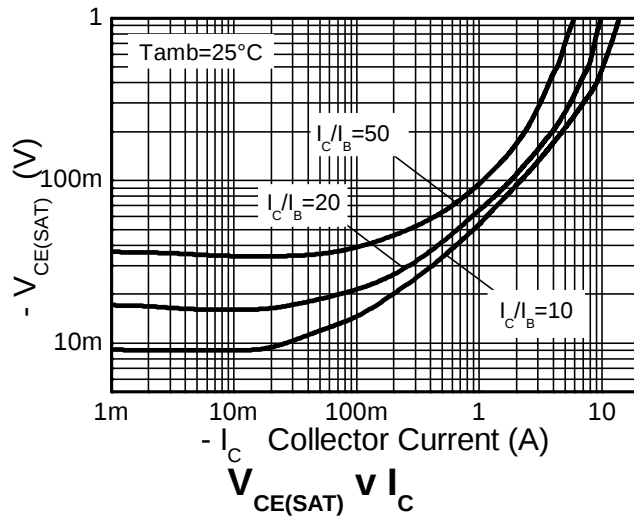


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-100	-120	-	V	I _C = -100μA
Collector-Emitter Breakdown Voltage	BV _{CER}	-100	-120	-	V	I _C = -1μA, R _B ≤ 1kΩ
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-60	-80	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.1	-	V	I _E = -100μA
Collector-Base Cutoff Current	I _{CBO}	-	<1	-20	nA	V _{CB} = -80V
			-	-0.5	μA	V _{CB} = -80V, T _A = +100°C
Collector-Emitter Cutoff Current	I _{CER} R ≤ 1kΩ	-	<1	-20	nA	V _{CB} = -80V
			-	-0.5	μA	V _{CB} = -80V, T _A = +100°C
Emitter Cutoff Current	I _{EBO}	-	<1	-10	nA	V _{EB} = -6V
Static Forward Current Transfer Ratio (Note 9)	h _{FE}	100	250	-	-	I _C = -10mA, V _{CE} = -1V
		100	200	300		I _C = -2A, V _{CE} = -1V
		45	90	-		I _C = -5A, V _{CE} = -1V
		10	25	-		I _C = -10A, V _{CE} = -1V
Collector-Emitter Saturation Voltage (Note 9)	V _{CE(sat)}	-	-15	-25	mV	I _C = -100mA, I _B = -10mA
		-	-55	-70		I _C = -1A, I _B = -100mA
		-	-90	-120		I _C = -2A, I _B = -200mA
		-	-195	-250		I _C = -5A, I _B = -500mA
Base-Emitter Saturation Voltage (Note 9)	V _{BE(sat)}	-	-1,030	-1,150	mV	I _C = -5A, I _B = -500mA
Base-Emitter Turn-On Voltage (Note 9)	V _{BE(on)}	-	-920	-1,020	mV	I _C = -5A, V _{CE} = -1V
Output Capacitance (Note 9)	C _{obo}	-	48	-	pF	V _{CB} = -10V, f = 1MHz
Transition Frequency	f _T	-	120	-	MHz	V _{CE} = -10V, I _C = -100mA f = 50MHz
Switching Time	t _{on}	-	39	-	ns	V _{CC} = -10V, I _C = -1A I _{B1} = -I _{B2} = -100mA
	t _{off}	-	370	-		

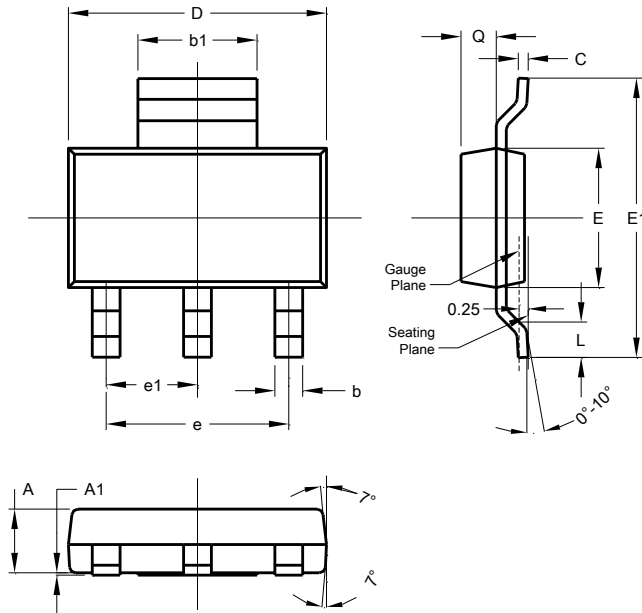
Note: 9. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



Package Outline Dimensions

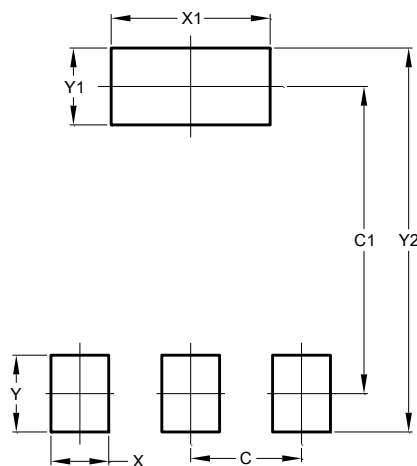
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b1	2.90	3.10	3.00
b2	0.60	0.80	0.70
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	—	—	4.60
e1	—	—	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

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